GainForce Technology Co.,Ltd

嘉光科技股份有限公司

承認書

APPROVAL SHEET

品 名:	Ante	n n a
MODEL NAME	A T 3	216
料 號:	AT3216-B5F	R5HAAT/LF
PART NUMBER	11320Y1	1161A1
客戶名稱:	永	洋
CUSTOMER		
供應商:	Gain	Force
VENDOR		
使用機種:		
MODEL		
聯絡人:		
聯絡雷話:	(02) 288	0-1838
ANT HELL	(02) 200	0 1000
附 件:		
	1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-	■ 1
ACCESSORIES	■規格書	■樣品
	SPECIFICATION	SAMPLE
	■圖樣	■檢驗報告
	DRAWING	TEST REPORT

認可狀況:

(APPROVED STATUS)



版次.:_A版

1.	零件基本資料	-P3
2.	圖面(mechanical drawing)	P4
3.	規格(specification)	-P3~P10
4.	性能檢測報告(Performance Test Report)	
	甲. 可靠度測試報告(Rellabibility test)	P7
	乙. 各項性能測試報告(performance report)	P7
5.	包裝方式(Packing information)	-P9
6.	ROHS 檢測報告(ROHS Test Report)	P24~P30
7.	物質成份分析表	P16
8.	物質成份元素表	P15
9.	永洋 ROHS 値管制標	P17
10.	永洋有害物質調查表	P13~P14
11.	製程溫度資訊(ThermalProfile),	P8
12.	54 階承認書 Check List	-P20
13.	Product Hazardous Substance Report	P11~P12



AT3216 Series Multilayer Chip Antenna

Features

- Monolithic SMD with small, low-profile and light-weight type.
- Wide bandwidth

Applications

❖5~6GHz wireless communication system



Specifications

Part Number	Frequency Range (MHz)	Peak Gain (XZ-V)	Average Gain (XZ-V)	VSWR	Impedance
AT3216 -B5R5HAA_	5150~5875	2.0 dBi typ.	-2.5 dBi typ.	2 max.	50 Ω

Q'ty/Reel (pcs) : 3,000 pcs Operating Temperature Range : $-40 \sim +85$ °C Storage Temperature Range : $-40 \sim +85$ °C Power Capacity : 500mW max.

Part Number

① Туре	AT : Antenna	② Dimensions (L × W)	3.2× 1.6 mm
3 Material Code	В	Frequency Range	5R5=5500MHz
S Specification Code	НАА	6 Packaging	T: Tape & Reel B: Bulk
∇ Soldering	=lead-containing /LF=lead-free		

Terminal Configuration

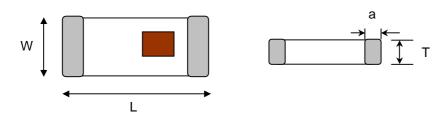


No.	Terminal Name	No.	Terminal Name			
1	Feeding Point	2	NC			



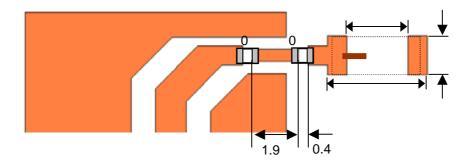
Dimensions and Recommended PC Board Pattern

Unit: mm

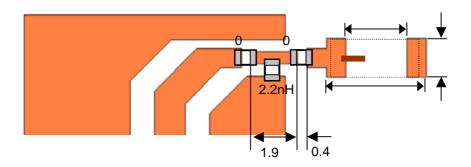


Mark	L	W	Т	а
Dimensions	3.2±0.2	1.6±0.2	1.3+ 0.1/-0.2	0.5±0.3

(a) Without Matching Circuits



(b) With Matching Circuits

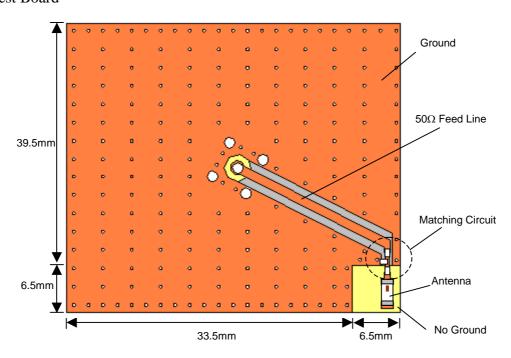


*Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.



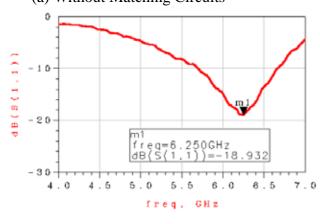
Typical Electrical Characteristics (T=25°C)

❖Test Board

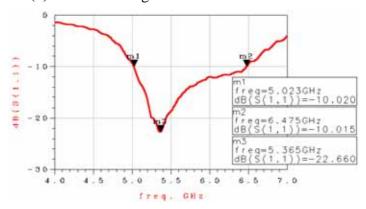


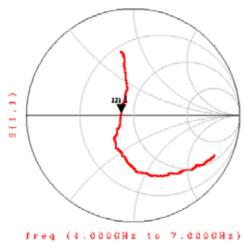
❖Return Loss

(a) Without Matching Circuits



(b) With Matching Circuits



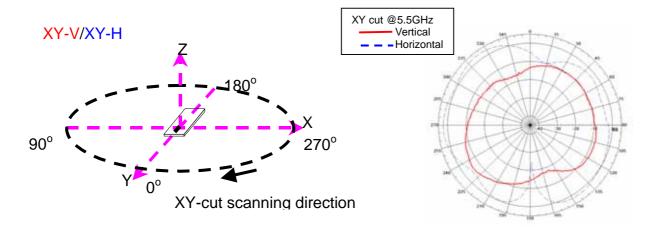


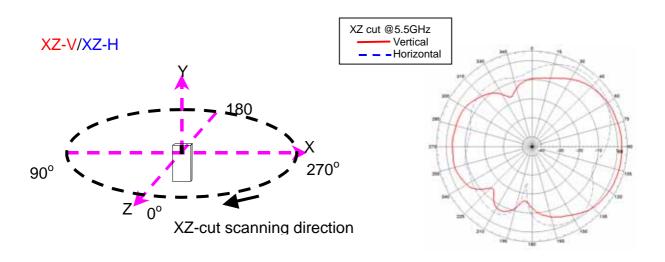
m3 m1

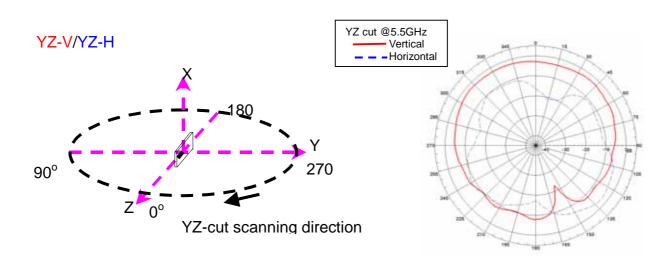
freq (4.000GHz to 7.000GHz)



Radiation Patterns







Advanced Ceramic X Corp.

16 Tzu Chiang Road, Hsinchu Industrial District Hsinchu Hsien 303, Taiwan TEL:886-3-5987008 FAX:886-3-5987001

E-mail: acx@acxc.com.tw

http://www.acxc.com.tw



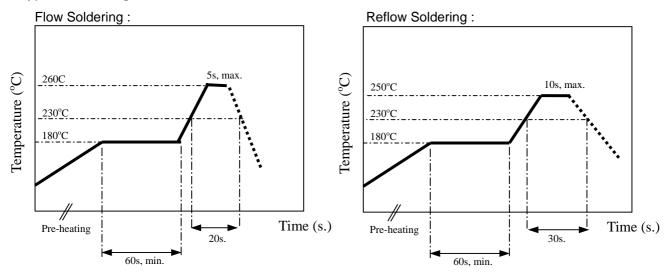
Mechanical & Environmental Characteristics

		Requirements		Procedure
Solderability	1. 2.	No apparent damage More than 75% of the terminal electrode shall be covered with new solder		
Thermal shock (Temperature Cycle)	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3. 4.	One cycle/ step 1: 85 ± 5 °C for 20sec step 2: -40 ± 3 °C for 20sec Cycle time: 30min No. of cycles: 100 Recovery: 1-2hrs
Heat Resistance	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3.	Temperature: 85± 2 °C Duration: 24±2hrs Recovery: 1-2hrs
Low Temperature Resistance	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3.	
Humidity Resistance	1. 2.	No apparent damage Fulfill the electrical specification after test	1. 2. 3. 4.	Humidity: 80% ~ 85% RH Duration: 1000±48hrs
Soldering strength (Push strength)	1. 9.8N minimum			Solder specimen onto test jig. Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction
Deflection (Bending)	1. 2.	No apparent damage Fulfill the electrical specification	,	Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. Apply a bending force of 2mm deflection Pressure Rod R230 90mm
Drop Shock	1.	No apparent damage	1.	Dropped onto hard wood from height of 50 cm for 3 times; each x,y and z direction except terminal direction



Typical Soldering Profile

❖Typical Soldering Profile for Lead-free Process



The sample must be pre-heated before soldering .The temperature difference between preheating and soldering must be within 150 .

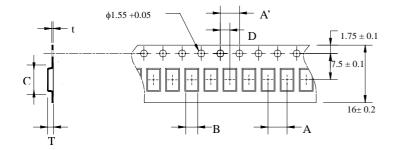
Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.



Taping Specifications

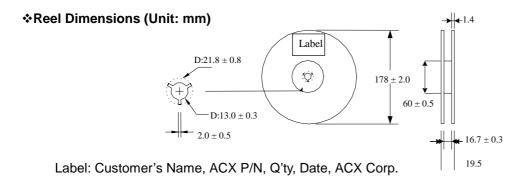
❖Tape Dimensions (Unit: mm)



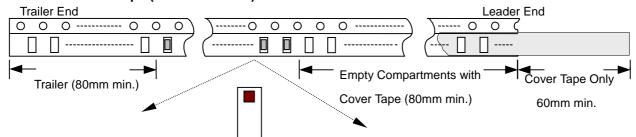
Туре	A	A'	В	С	D	t	Т
3216	4.0±	4.0±	1.9±	3.5±	2.0±	0.20±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.4
5020	4.0±	4.0±	2.4±	5.5±	2.0±	0.20±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.4
7020	4.0±	4.0±	2.4±	7.3±	2.0±	0.22±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.55
7635	8.0±	4.0±	3.75±	7.85±	2.0±	0.30±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.40
8516	4.0±	4.0±	1.85±	8.70±	2.0±	0.25±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.40
9520	4.0±	4.0±	2.3±	9.7±	2.0±	0.22±	Max.
	0.1	0.1	0.1	0.1	0.1	0.05	1.45
R130	8.0±	4.0±	3.35±	10.35	2.0±	0.25±	Max.
	0.1	0.1	0.1	±0.1	0.1	0.05	1.40

❖Quantity

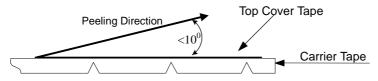
Туре	3216	3216 5020 7020 7635			8516	9520	R130	
Quantity	3,000pcs	2,000	1,000 pcs	1,000 pcs	1000pcs	1,000 pcs	1,000 pcs	
/per reel	3,000pcs	2,000	1,000 pcs	1,000 μεδ	τουορισ	1,000 pcs	1,000 pcs	



❖Leader and Trailer Tape (Plastic material)



❖Peel-off Force



Peel-off force should be in the range of 0.1-0.6~N at a peel-off speed of $300\pm10~mm/min$.

ACX

❖Storage Conditions

- (1) Temperature: 15 ~35 , relative humidity (RH): 45~75%.
- (2) Non-corrosive environment
- (3) Products should be used within six months of receipt.

Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.



Product Hazardous Substance Report

Model Name:

Part Number: 11320Y11161A1

Date: 2013.07.12

							RoHS Dire								rective 2011/65/EC & PFOS Dire				
ľ	tem	Part Number	Description	Component Suppliers	SUPPLIER PN	Weight (mg)	Sub-Item	Sub-parts	原材料顏色	鍍層存在與否/鍍層材質說明	分離之	Effective date							
Į	頁目	料號	品名	廠商名稱	原廠/製造商型號	零件重量	分離材質	Homogeneous Material	(塑膠、油墨及漆料必塡)	If the plating layer exist or	均匀材質	報告生效日	1,000	100	1,000				
							項目	分離之均勻材質名稱	The color of raw material	not?(Y/N)/If yes, please describe the	單重(mg)		Pb	Cd	Hg				
									(Required for plastic, ink and paint)	material of the plating layer			鉛	钃	汞				
		11320Y11161A1	Chip Antenna AT3216- B5R5HAAT/LF	嘉光科技 (ACX)	AT3216-BSR5HAAT/LF	22.096	1.	Ceramic	NA	N	20.026	2013/6/7 2013/6/3	57,400	N.D	N.D				
							2.	Termination Plating	NA	Y(Ni / Sn)	2.070	2013/5/21	N.D	N.D	N.D				

ctive 20	tive 2006/122/EC REACH Regulation (EC) ¹										REACH Regulation (EC) No 1907/2006 Halogen Free IEC 61249-2-21				-21						
	Control Substance; mg/kg=ppm Analysis report No. Laboratory Test Materia							Material Declaration/	物質成化	分元素表	Contanted	Candidate List	SVHC	150	0ppm	Laboratory Test	Material	備註			
1,000	1,000	1,000			Conc	erned			實驗室分析報告號碼	Report (Hyperlink)	Exception Declaration	元素/化合物	元素/化合物	Substance	Update Date	Contanted List	Conc	erned	Report (Hyperlink)	Declaration	Remark
Cr+6	PBB	PBDE	HBCCD	DEHP	BBP	DBP	PFOA	PFOS			物質宣告書或排外宣	名稱	比重 (%)	of SVHC	<u>by</u>	(Hyperlink)	Cl	Br	第三公證單位化學		i
六價鉛	·									分析報告	告證明(Hyperlink)						氯	溴	分析報告	物質宣告書	
												Al2O3	42.82%								
										CE_2013_55890.pd f		Pb compounds	8.56%								
N.D	N.D	N.D	-	-	-	-	N.D	N.D	CE/2013/55890 CE/2013/52137A			SiO2	40.54%	No	18/06/2012		N.D	N.D			
									,,	CE_2013_52137A.		CaO	4.26%						T 2012 (2127)		
										pui		Ag	3.83%						CE_2013_52137A. pdf		
									CE/2013/55138	POF		Ag	65.14%							'	
Negativ	e N.D	N.D	-	-	-	-	N.D	N.D	CE/2013/53138 CE/2013/52137A	CE_2013_52138.pd		Ni	11.62%	No	18/06/2012		N.D	N.D			
									CL/2013/32137A	I		Sn	23.24%								

		 質 成	份 元素	 表	
組成物	材質	材質比重		元素比重	備註
			Al2O3	38.80%	
			Pb compounds		
Ceramic	Powder	90.63%	SiO2	36.74%	
			CaO	3.86%	
			Ag	3.47%	
m	Ag paste;	0.627	Ag	6.10%	
Termination	plating	9.63%	Ni	1.09%	
	1		Sn	2.18%	

物質成份分析表

料 號	組成物名稱	鉛(Pb)	鎘(Cd)	汞(Hg)	六價鉻 (Cr+6)	多溴聯苯 (PBBs)	多溴化二苯 乙醚 (PBDEs)	ROHS檢測報告編號	檢測日期	排除條例
AT3216-B5R5HAAT/LF 11320Y11161A1	Ceramic	57400	N.D	N.D	N.D	N.D	N.D	CE/2013/55890	2013/6/7	EU RoHS (2002/95/EC) Exemption 7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.
	Termination	N.D	N.D	N.D	N.D	N.D	N.D	CE/2013/52138	2013/5/21	

註:1.若物質成份含量超出RoHS所限定之含量,但在RoHS的排除條款中,請供應商在檢測報告及表單中清楚註明是在一條文中所規定,以方便查核。

2.若物質超出RoHS限定值,請附上材質證明,以證明所含之成份是RoHS所允許。

永洋 RoHS 値管制標準

Classification	Restr	icts Substar	ices	AMIT Standard	備註
	Lead (Lead Compounds)	鉛及其 化合物	Pb	800ppm	例外(Exception): 1.鉛使用於電子器材中陶 製零件不受此限。 2.鋼合金:0.35%(3500ppm) 3.鋁合金:0.40%(4000ppm) 4.銅合金:4%(40000ppm)
Heavy metals (重金屬)	Cadmium (Cadmium Compounds)	鍋及其 化合物	Cd	80ppm	
	Mercury (Mercury Compounds)	汞及其 化合物	Hg	800ppm	
	Hexavalent Chromium	六價鉻 及其化 合物	Cr^{+6}	800ppm	
Bromided organic	PBBs	聚溴聯 苯	C12H12- XBrXO (X=1~10)	800ppm	
compounds (含 溴有機化合物)	PBDEs PBDOs	聚溴二 苯醚	C12H12- XBrXO (X=1~10)	800ppm	
Heavy metals (重金屬) (applicable to packaging(包裝 材適用))	Pb+Cd+Hg + Cr ⁺⁶ (applicable to packaging)	鉛+鎘+ 汞+六價 鉻(包裝 材適用)	Pb+Cd+H g+ <i>Cr</i> +6 (包裝材 適用)	80ppm(Cd <5 ppm)	含棧板、膠膜、膠帶、膠袋、 緩衝材、發泡材、紙箱、 label、Tray、束帶、乾燥包、 真空袋、溼度指示卡等及上述 材料印刷所用油墨。



Advanced Ceramic X Corporation

16 Tzu Chiang Road, Hsinchu Industrial District
Hsinchu Hsien, Taiwan 303 R.O.C.
TEL: 886-3-598-7008 FAX: 886-3-598-7001 e-mail: acxc@acxc.com.tw

Guarantee letter

We, Advanced Ceramic X (ACX) Corporation, are hereby warrants and guarantee that ACX products fully comply with the international specification set froth herein (i.e. IEC61249-2-21). Total Br < 900 PPM, Total Cl < 900 PPM, Br+Cl < 1500 PPM. ACX P/N: <u>AT3216-B5R5HAAT/LF</u>

Company : 璟德電子工業股份有限公司 Advanced Ceramic X Corporation

Title

: QM Director

Signed by

Vanner Lin

Date

: 2013/7/15



Advanced Ceramic X Corporation

16 Tzu Chiang Road, Hsinchu Industrial District
Hsinchu Hsien, Taiwan 303 R.O.C.
TEL: 886-3-598-7008 FAX: 886-3-598-7001 e-mail: acxe@acxc.com.tw

Guarantee letter regarding substances included in materials

Our company hereby guarantees that we will meet the requirements of EU RoHS to ban all environment-related substances included in the materials (including attachments, packages, and all the matters delivered with the materials).

The observable scope of the environment-related substances would include the following substances.

This guarantee letter covers following product: AT3216-B5R5HAAT/LF

[Environment-related Substance to be Controlled]

	The names of the substances
RoHS	Cadmium and cadmium compounds
	Lead and lead compounds
	Mercury and mercury compounds
	Hexavalent chromium compounds
	Polybrominated biphenyls (PBB)
	Polybrominated biphenyl ethers (PBDE)

%Full fill RoHS requirement. The lead contained in ACX product is exempted from the requirement of ROHS

7(c)-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound

Company : 環德電子工業股份有限公司 Advanced Ceramic X Corporation

Title QM Director

Signed by: Homen Lun

Date : 2013/7/15



電子類物料承認書 CHECK LIST v3.0 版

※ 第一頁為承認書(APPROVAL SHEET)封面,必須註明以下資訊,包括:
■ 1、永洋料號(AMIT P/N)
■2、供應商料號與供應商型號(Part NO, Internal code)
■3、承認書版次,依承認書初次開始編製(如 A、B、C or 1、2、3),勿以料號版次編製
■4、產品名稱(如彩盒、說明書、外箱…等)
※ 第二頁必需爲承認書的目錄,而且必須符合下列的格式:
※ 目錄(Specification Index)
■.1、規格(specification)
■ 2、圖面(mechanical drawing)(<u>須包含本體表面印刷文字(廠牌、型號、date code)說明</u>)
■ 3、性能檢測報告(Performance Test Report)
■ a、可靠度測試報告(Reliability Test Report)(shielding case、外露 connector 鹽霧測試
報告、電池必須提供)
■ b、各項性能測試報告(performance report)(天線、電池)
■ 4、最小之內包裝方式(Packing information)(卷、管、盤狀物料,若 data sheet 已說明則不
需另外提供)
□ 5、製程溫度資訊(Thermal Profile),爲獨立一份檔案(針對永洋主、被動元件一定需提供)
(項目 6 爲針對 PCB 供應商須提供,)
□ a、文字、孔位、PAD 點及線路等底片
□ b、切片報告(microdection report)及切片樣本
□ c、阻抗報告(impedance report)及阻抗條
□ d、成品出貨檢驗報告
□ e、疊構方式切面圖及連板成型圖
□ f、PCB 耐溫耐熱測試報告
□ g、材質證明及 UL 認證
☐ h、GERBER DRAWING
□ i、製作規範
■ 7、永洋 RoHS 調査表(請另外填寫"永洋 RoHS 調査表範本_for 零件供應商(Excel 檔)"
並按照內容範例及說明指示提供所需要的資料,並將第三公證單位測試報告檔案
附加至 Excel 檔中。)
請注意
※ 限用物質承諾保證書須在送樣承認前經 AMIT 稽核審查合格,方可進行承認流程。
※ 送樣承認時須同時檢附 AMIT RoHS 調查表,Excel File。
※ 請務必依 Check List 所條列之項目,於承認書送出時確認資料是否完整正確 ※

AMIT 申請人員確認: (永洋申請人姓名); 供應商確認: (尹廣汶)

Advance Multimedia Internet Technology Inc. 限用物質承諾保證書 Guarantee of Hazardous Substances

供應商名稱 (Supplier's Name): 嘉光科技股份有限公司

本公司特此保證:保證供應給<u>水洋科技股份有限公司</u>的產品滿足以下列出的有害物質限值的要求,並於製程中不使用該項物質:

We warrant that all the products supplied to Advance Multimedia Internet Technology Inc. satisfy the following threshold requirements concerning hazardous substances, and the use of these substances used in the production of

supplied products are in compliance with such threshold requirements: 永洋針對ROHS規定 SONY SS-00259限 Name of hazardous 有害物質名稱 substance 限定值 (limit for 定值 (limit for SONY RoHS) -00259) ppm (mg/kg) ppm (mg/kg) 80 Solder:75ppm Plastics/Wire Cadmium and its compounds 镉及其混合物 5ppm Solder:20ppm Plastic/Painting/W Lead and its compounds (Pb) 800 鉛及其混合物 *鋼(steel) 3500 ire 100ppm *紹(aluminum) 4000 *銅(copper) 4% Solder: 1000ppm 800 Mercury and its compounds 汞及其混合物 Chromium VI and its 800 六價鉻及其混合 compounds (Cr) 800 Polybrominated Biphenyls 多溴聯苯(PBB) (PBB) Polybromodiphenyl ether 800 多溴二苯醚 (PBDE) Packaging: 100 Packaging: 80 鍋+鉛+汞+六價 Cd+ Pb+ Hg+ Cr 所有乾電池及蓄電池之產品應符合以下規定: Mercury and its 5PPM 5PPM 汞及其混合物 1 PPM(供中國用 25mg/cell compounds (Hg) 的錳電池及碱錳電



Cadmium and its compounds

Lead and its compounds (Pb)

额及其混合物

鉛及其混合物

Entire Specimen shall be follow the destruct testing of RoHS Homogenous.

250PPM

4,000PPM





池)

4,000PPM

0

Advance Multimedia Internet Technology Inc.

※本公司特此保證,自<u>2006</u>年<u>01</u>月<u>01</u>日起,提供給<u>永洋科技股份有限公司</u>產品或零件中,符合RoHS或Sony SS-00259的危害物質限質要求之含量標準。

We also warrant that the products listed hereafter, which will be supplied to Advance Multimedia Internet Technology Inc. (Amit)

from 2006/01/01, satisfy RoHS and/or Sony SS-00259 requirements concerning hazardous substances.

※若本公司違反上述限值標準,因而造成貴公司的一切損失及風險,本公司將承擔一 切責任,並承擔補償貴公司因此發生的一切費用。

We shall pay to Amit all damages and costs including, but not limited to, reasonable attorneys' fees, damage awards, payments to settle claims, and the cost of Amit internal resources handling such matters if the parts delivered to Amit failed to meet the abovementioned requirements.

※若本公司設計變更涉及材質改變或製程改變或製造場所改變,必須重新提出「環境管理物質」檢測報告供 貴公司存查,若未提出相關之檢測報告,而經貴公司或貴公司之客戶發現者,除需負擔貴公司發生之一切費用(包含但不限於檢測費用、損失)外,另需給付懲罰性違約金新台幣100,000元。

We shall propose again that the examining report supports Amit to be keep for reference on the "Environmental management material", if the product design change involve material or process or manufacture place if not provide any testing report, but discovered by AMIT or AMIT's customers, shall be share the full expenses cause by the said issue (including but no limited of testing expenselose), but shall addition pay in the amount of NTD 100,000 for penalty.

※ 本公司對限用物質(RoHS)或(SS-00259),承諾之料件內/外箱標示。

The following label (please check the appropriate box) will be used for the of shipping RoHS and/or Sony SS-00259 compliant parts on their internal and external packaging:

□按永洋科技股份	分有限公司之規定標示如下	
Amit's label:		



26mmx26mm 綠底白字

□標示不同於永洋科技股份有限公司,說明如下:

Our own label:

※本保證書請蓋公司大小章及騎縫章後正本寄回永洋科技股份有限公司。 Please sign and return this Guarantee Form back to Amit.

公司名稱(Company Name): 嘉光科技股份有限公司

回覆日期(Date): 2007/06/26

負責人簽名(Authorized Signature):

公司章(Supplier's Company Stamp):









No.: CE/2013/55889 Date: 2013/06/07

Page: 1 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
16, TZU CHIANG ROAD, HSINCHU INDUSTRIAL DISTRICT, HSINCHU HSIEN, TAIWAN 303

The following sample(s) was/were submitted and identified by/on behalf of the applicant as :

Sample Submitted By

: ADVANCED CERAMIC X (ACX) CORPORATION

Sample Description

: MULTILAYER LTCC-L COMPONENTS (CERAMIC BODY)

Style/Item No.

: AD SERIES, AT SERIES, BD SERIES, BF SERIES, BL SERIES, BM SERIES, BW SERIES, CD SERIES, CF SERIES, CP SERIES, DM SERIES, DP SERIES, DS SERIES, EF SERIES, ES SERIES, FA SERIES, FB SERIES, FD SERIES, FM SERIES, GS SERIES, HI SERIES, HF SERIES, HM SERIES, HS SERIES, LF SERIES, OM SERIES, OS SERIES, PD SERIES, NF SERIES, QS SERIES,

SF SERIES, TS SERIES, TP SERIES, LTCC SUBSTRATES

Sample Receiving Date

: 2013/05/31

Testing Period

: 2013/05/31 TO 2013/06/07

Test Requested

- : (1) As specified by client, with reference to RoHS Directive 2011/65/EU Annex II to determine Cadmium, Lead, Mercury, Cr(VI), PBBs, PBDEs contents in the submitted sample.
 - (2) As specified by client, to test Halogen-Fluorine, Chlorine, Bromine, Iodine contents in the submitted sample.

Test Method: Please refer to next page(s).

Test Result(s) : Please refer to next page(s).



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No.: CE/2013/55889 Date: 2013/06/07

Page: 2 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
16, TZU CHIANG ROAD, HSINCHU INDUSTRIAL DISTRICT, HSINCHU HSIEN, TAIWAN 303

Test Result(s)

PART NAME No.1 : MULTILAYER LTCC-L COMPONENTS (CERAMIC BODY)

Toot Itom(a)	Unit	Method	MDL	Result	
Test Item(s)	Unit	Method	MIDL	No.1	
Cadmium (Cd)	mg/kg	With reference to IEC 62321: 2008 and performed by ICP-AES.	2	n.d.	
Lead (Pb)	mg/kg	With reference to IEC 62321: 2008 and performed by ICP-AES.	2	9	
Mercury (Hg)	mg/kg	With reference to IEC 62321: 2008 and performed by ICP-AES.	2	n.d.	
Hexavalent Chromium Cr(VI)	mg/kg	With reference to IEC 62321: 2008 and performed by UV-VIS.	2	n.d.	
Sum of PBBs			-	n.d.	
Monobromobiphenyl			5	n.d.	
Dibromobiphenyl			5	n.d.	
Tribromobiphenyl			5	n.d.	
Tetrabromobiphenyl			5	n.d.	
Pentabromobiphenyl			5	n.d.	
Hexabromobiphenyl			5	n.d.	
Heptabromobiphenyl			5	n.d.	
Octabromobiphenyl			5	n.d.	
Nonabromobiphenyl			5	n.d.	
Decabromobiphenyl	mg/kg	With reference to IEC 62321: 2008 and	5	n.d.	
Sum of PBDEs	IIIg/kg	performed by GC/MS.	-	n.d.	
Monobromodiphenyl ether			5	n.d.	
Dibromodiphenyl ether			5	n.d.	
Tribromodiphenyl ether			5	n.d.	
Tetrabromodiphenyl ether			5	n.d.	
Pentabromodiphenyl ether			5	n.d.	
Hexabromodiphenyl ether			5	n.d.	
Heptabromodiphenyl ether			5	n.d.	
Octabromodiphenyl ether			5	n.d.	
Nonabromodiphenyl ether			5	n.d.	
Decabromodiphenyl ether			5	n.d.	

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No.: CE/2013/55889 Date: 2013/06/07

Page: 3 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
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Test Item(s)	Unit	Method	MDL	Result
l est item(s)	Onit	Wethou		No.1
Halogen				
Halogen-Fluorine (F) (CAS No.: 14762-94-8)		With reference to BS EN 14582:2007. Analysis was performed by IC.	50	n.d.
Halogen-Chlorine (CI) (CAS No.: 22537-15-1)	ma/ka		50	n.d.
Halogen-Bromine (Br) (CAS No.: 10097-32-2)	mg/kg		50	n.d.
Halogen-lodine (I) (CAS No.: 14362-44-8)			50	n.d.

Note:

1. mg/kg = ppm; 0.1wt% = 1000ppm

2. n.d. = Not Detected

3. MDL = Method Detection Limit

4. " - " = Not Regulated



No.: CE/2013/55889

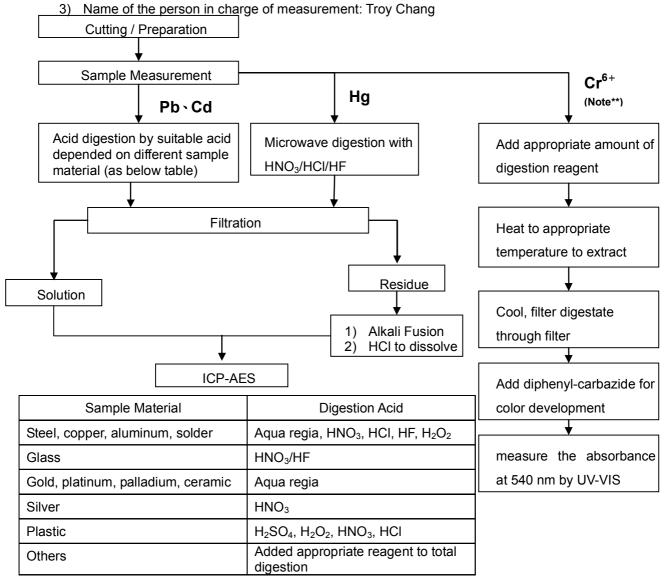
Date: 2013/06/07

Page: 4 of 7

ADVANCED CERAMIC X (ACX) CORPORATION

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- 1) These samples were dissolved totally by pre-conditioning method according to below flow chart. (Cr⁶⁺ test method excluded)
- 2) Name of the person who made measurement: Climbgreat Yang



Note**: (1) For non-metallic material, add alkaline digestion reagent and heat to 90~95℃.

(2) For metallic material, add pure water and heat to boiling.



No. : CE/2013/55889 Date

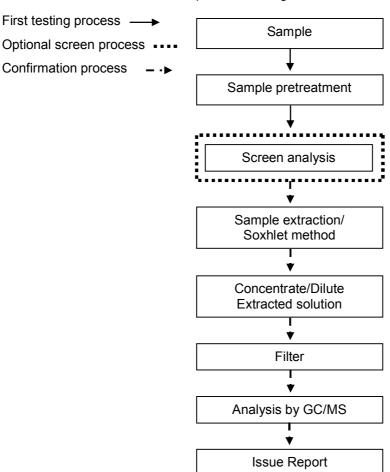
Date: 2013/06/07

Page: 5 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
16, TZU CHIANG ROAD, HSINCHU INDUSTRIAL DISTRICT, HSINCHU HSIEN, TAIWAN 303

PBB/PBDE analytical FLOW CHART

- Name of the person who made measurement: Roman Wong
- Name of the person in charge of measurement: Troy Chang





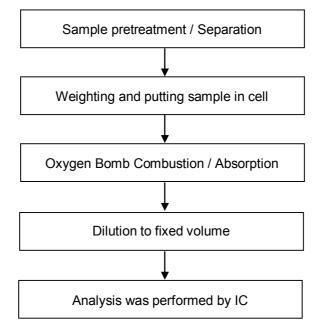
No.: CE/2013/55889 Date: 2013/06/07

Page: 6 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
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Analytical flow chart of halogen content

- Name of the person who made measurement: Rita Chen
- Name of the person in charge of measurement: Troy Chang





No.: CE/2013/55889

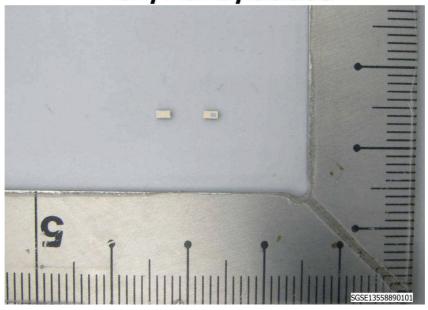
Date: 2013/06/07

Page: 7 of 7

ADVANCED CERAMIC X (ACX) CORPORATION
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* The tested sample / part is marked by an arrow if it's shown on the photo. *

CE/2013/55889



** End of Report **